

**APTS/APXS003A0X: Non-Isolated DC-DC Power Modules:
4.5Vdc –14Vdc input; 0.59Vdc to 5.5Vdc output; 3A Output Current**

RoHS Compliant



Applications

- Distributed power architectures
- Intermediate bus voltage applications
- Telecommunications equipment
- Servers and storage applications
- Networking equipment

Description

The APTS/APXS003A0X series of power modules are non-isolated dc-dc converters that can deliver up to 3A of output current. These modules operate over a wide range of input voltage ($V_{IN} = 4.5\text{Vdc}-14\text{Vdc}$) and provide a precisely regulated output voltage from 0.59Vdc to 5.5Vdc, programmable via an external resistor. Features include remote On/Off, adjustable output voltage, over current and overtemperature protection, and output voltage sequencing (APTS versions). A new feature, the Tunable Loop, allows the user to optimize the dynamic response of the converter to match the load.

Features

- Compliant to RoHS EU Directive 2002/95/EC (Z versions)
- Compatible in a Pb-free or SnPb reflow environment (Z versions)
- Wide Input voltage range (4.5Vdc-14Vdc)
- Output voltage programmable from 0.59Vdc to 5.5Vdc via external resistor
- Tunable Loop to optimize dynamic output voltage response
- Flexible output voltage sequencing EZ-SEQUENCE – APTS versions
- Low output ripple and noise
- Fixed switching frequency
- Output overcurrent protection (non-latching)
- Overtemperature protection
- Remote On/Off
- Cost efficient open frame design
- Small size: 12.2 mm x 12.2 mm x 6.25 mm (0.48 in x 0.48 in x 0.246 in)
- Wide operating temperature range (-40°C to 85°C)
- UL^* 60950-1 Recognized, $CSA^\dagger$ C22.2 No. 60950-1-03 Certified, and $VDE^\ddagger$ 0805:2001-12 (EN60950-1) Licensed
- ISO** 9001 and ISO 14001 certified manufacturing facilities

* UL is a registered trademark of Underwriters Laboratories, Inc.

† CSA is a registered trademark of Canadian Standards Association.

‡ VDE is a trademark of Verband Deutscher Elektrotechniker e.V.

** ISO is a registered trademark of the International Organization of Standards

Absolute Maximum Ratings

Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. These are absolute stress ratings only, functional operation of the device is not implied at these or any other conditions in excess of those given in the operations sections of the data sheet. Exposure to absolute maximum ratings for extended periods can adversely affect the device reliability.

Parameter	Device	Symbol	Min	Max	Unit
Input Voltage Continuous	All	V_{IN}	-0.3	15	Vdc
Sequencing Voltage	APTS	V_{SEQ}	-0.3	V_{IN}	Vdc
Operating Ambient Temperature (see Thermal Considerations section)	All	T_A	-40	85	°C
Storage Temperature	All	T_{stg}	-55	125	°C

Electrical Specifications

Unless otherwise indicated, specifications apply over all operating input voltage, resistive load, and temperature conditions.

Parameter	Device	Symbol	Min	Typ	Max	Unit
Operating Input Voltage	All	V_{IN}	4.5	—	14.0	Vdc
Maximum Input Current ($V_{IN}=4.5V$ to $14V$, $I_O=I_{O,max}$)	All	$I_{IN,max}$			3.5	Adc
Input No Load Current ($V_{IN} = 12.0Vdc$, $I_O = 0$, module enabled)	$V_{O,set} = 0.6 Vdc$ $V_{O,set} = 3.3Vdc$	$I_{IN,No load}$ $I_{IN,No load}$		17 55		mA
Input Stand-by Current ($V_{IN} = 12.0Vdc$, module disabled)	All	$I_{IN,stand-by}$		1		mA
Inrush Transient	All	I^2t			1	A ² s
Input Reflected Ripple Current, peak-to-peak (5Hz to 20MHz, 1μH source impedance; $V_{IN}=0$ to 14V, $I_O=I_{O,max}$; See Test Configurations)	All			TBD		mAp-p
Input Ripple Rejection (120Hz)	All			50		dB

CAUTION: This power module is not internally fused. An input line fuse must always be used.

This power module can be used in a wide variety of applications, ranging from simple standalone operation to an integrated part of sophisticated power architecture. To preserve maximum flexibility, internal fusing is not included; however, to achieve maximum safety and system protection, always use an input line fuse. The safety agencies require a fast-acting fuse with a maximum rating of 5A (see Safety Considerations section). Based on the information provided in this data sheet on inrush energy and maximum dc input current, the same type of fuse with a lower rating can be used. Refer to the fuse manufacturer's data sheet for further information.

Electrical Specifications (continued)

Parameter	Device	Symbol	Min	Typ	Max	Unit
Output Voltage Set-point (with 0.5% tolerance for external resistor used to set output voltage)	All	$V_{O, set}$	-1.5		+1.5	% $V_{O, set}$
Output Voltage (Over all operating input voltage, resistive load, and temperature conditions until end of life)	All	$V_{O, set}$	-3.0	—	+3.0	% $V_{O, set}$
Adjustment Range (selected by an external resistor)	All	V_O	0.59		5.5	Vdc
Remote Sense Range	All				0.5	Vdc
Output Regulation (for $V_O \geq 2.5Vdc$)						
Line ($V_{IN}=V_{IN, min}$ to $V_{IN, max}$)	All			—	+0.4	% $V_{O, set}$
Load ($I_O=I_{O, min}$ to $I_{O, max}$)	All			—	10	mV
Output Regulation (for $V_O < 2.5Vdc$)						
Line ($V_{IN}=V_{IN, min}$ to $V_{IN, max}$)	All			—	10	mV
Load ($I_O=I_{O, min}$ to $I_{O, max}$)	All			—	5	mV
Temperature ($T_{ref}=T_{A, min}$ to $T_{A, max}$)	All			—	0.4	% $V_{O, set}$
Remote Sense Range	All				0.5	V
Output Ripple and Noise on nominal output ($V_{IN}=V_{IN, nom}$ and $I_O=I_{O, min}$ to $I_{O, max}$ $C_{out} = 0.1\mu F // 10\mu F$ ceramic capacitors)						
Peak-to-Peak (5Hz to 20MHz bandwidth)	All		—	50	75	mV _{pk-pk}
RMS (5Hz to 20MHz bandwidth)	All			20	25	mV _{rms}
External Capacitance ¹						
Without the Tunable Loop						
ESR $\geq 1\text{ m}\Omega$	All	$C_{O, max}$	0	—	47	μF
With the Tunable Loop						
ESR $\geq 0.15\text{ m}\Omega$	All	$C_{O, max}$	0	—	1000	μF
ESR $\geq 10\text{ m}\Omega$	All	$C_{O, max}$	0	—	3000	μF
Output Current	All	I_O	0		3	A _{dc}
Output Current Limit Inception (Hiccup Mode)	All	$I_{O, lim}$			200	% $I_{O, max}$
Output Short-Circuit Current ($V_O \leq 250\text{mV}$) (Hiccup Mode)	All	$I_{O, s/c}$		6.7		mA
Efficiency	$V_{O, set} = 0.59Vdc$	η		73.3		%
$V_{IN} = 12Vdc$, $T_A = 25^\circ C$	$V_{O, set} = 1.2Vdc$	η		82.9		%
$I_O = I_{O, max}$, $V_O = V_{O, set}$	$V_{O, set} = 1.8Vdc$	η		86.5		%
	$V_{O, set} = 2.5Vdc$	η		88.9		%
	$V_{O, set} = 3.3Vdc$	η		90.6		%
	$V_{O, set} = 5.0Vdc$	η		92.6		%
Switching Frequency	All	f_{sw}	—	600	—	kHz
Dynamic Load Response						
($dI_O/dt = 10A/\mu s$; $V_{IN} = V_{IN, nom}$; $V_{out} = 1.8V$, $T_A = 25^\circ C$)						
Load Change from $I_O = 50\%$ to 100% of $I_{O, max}$; $C_O = 0$						
Peak Deviation	All	V_{pk}		220		mV
Settling Time ($V_O < 10\%$ peak deviation)	All	t_s		60		μs
Load Change from $I_O = 100\%$ to 50% of $I_{O, max}$; $C_O = 0$						
Peak Deviation	All	V_{pk}		240		mV
Settling Time ($V_O < 10\%$ peak deviation)	All	t_s		60		μs

¹ External capacitors may require using the new Tunable Loop feature to ensure that the module is stable as well as getting the best transient response. See the Tunable Loop section for details.

General Specifications

Parameter	Min	Typ	Max	Unit
Calculated MTBF ($I_O=I_{O, \max}$, $T_A=25^\circ\text{C}$) Telecordia Method		TBD		10^6 Hours
Weight	—	1.55 (0.0546)	—	g (oz.)

Feature Specifications

Unless otherwise indicated, specifications apply over all operating input voltage, resistive load, and temperature conditions. See Feature Descriptions for additional information.

Parameter	Device	Symbol	Min	Typ	Max	Unit
On/Off Signal Interface ($V_{IN}=V_{IN, \min}$ to $V_{IN, \max}$; open collector or equivalent, Signal referenced to GND) Device is with suffix "4" – Positive Logic Logic High (On/Off pin open – Module ON) Input High Current Input High Voltage Logic Low (Module OFF) Input Low Current Input Low Voltage	All All All All	I_{IH} V_{IH} I_{IL} V_{IL}	— 3.5 — -0.3	— — — —	10 $V_{IN, \max}$ 1 0.8	μA V mA V
Device Code with no suffix – Negative Logic (On/OFF pin is open collector/drain logic input with external pull-up resistor; signal referenced to GND) Logic High (On/Off pin open – Module OFF) Input High Current Input High Voltage Logic Low (Module ON) Input low Current Input Low Voltage	All All All All	I_{IH} V_{IH} I_{IL} V_{IL}	— 3.5 — -0.2	— — — —	1 $V_{IN, \max}$ 10 0.3	mA Vdc μA Vdc
Turn-On Delay and Rise Times ($V_{IN}=V_{IN, \text{nom}}$, $I_O=I_{O, \max}$, V_O to within $\pm 1\%$ of steady state) Case 1: On/Off input is enabled and then input power is applied (delay from instant at which $V_{IN} = V_{IN, \min}$ until $V_O =$ 10% of $V_{O, \text{set}}$) Case 2: Input power is applied for at least one second and then the On/Off input is enabled (delay from instant at which On/Off is enabled until $V_O = 10\%$ of $V_{O, \text{set}}$) Output voltage Rise time (time for V_O to rise from 10% of $V_{O, \text{set}}$ to 90% of $V_{O, \text{set}}$)	All All All	T_{delay} T_{delay} T_{rise}	— — —	2 2 4	— — —	msec msec msec
Output voltage overshoot ($T_A = 25^\circ\text{C}$ $V_{IN} = V_{IN, \min}$ to $V_{IN, \max}$, $I_O = I_{O, \min}$ to $I_{O, \max}$) With or without maximum external capacitance					3.0	% $V_{O, \text{set}}$
Over Temperature Protection (See Thermal Considerations section)	All	T_{ref}		TBD		$^\circ\text{C}$
Tracking Accuracy (Power-Up: 2V/ms) (Power-Down: 2V/ms) ($V_{IN, \min}$ to $V_{IN, \max}$; $I_{O, \min}$ to $I_{O, \max}$ $V_{\text{SEQ}} < V_O$)	APTS APTS	$V_{\text{SEQ}} - V_O$ $V_{\text{SEQ}} - V_O$			100 100	mV mV

Feature Specifications (cont.)

Parameter	Device	Symbol	Min	Typ	Max	Units
Input Undervoltage Lockout						
Turn-on Threshold	All				4.0	Vdc
Turn-off Threshold	All		3.6			Vdc
Hysteresis	All		0.4			Vdc
PGOOD (Power Good)						
Signal Interface Open Drain, $V_{\text{supply}} \leq 5\text{VDC}$						
Output Voltage Limit for PGOOD	All		90%		110%	$V_{\text{O, set}}$
Pulldown resistance of PGOOD pin	All			7	50	Ω

Characteristic Curves

The following figures provide typical characteristics for the APTS/APXS003A0X-SRZ (0.6V, 3A) at 25°C.

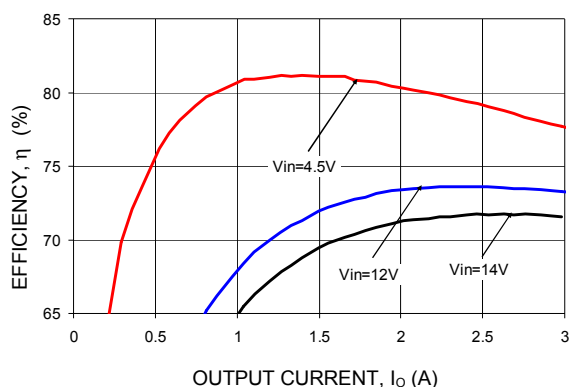


Figure 1. Converter Efficiency versus Output Current.

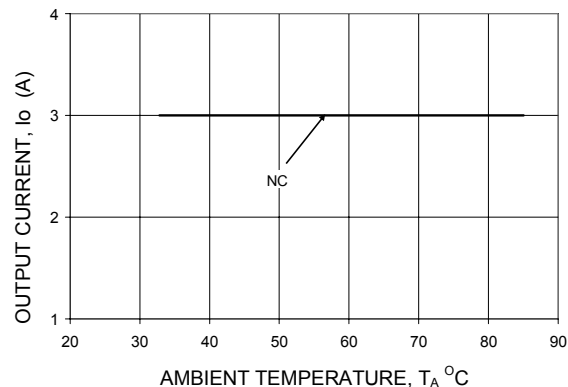


Figure 2. Derating Output Current versus Ambient Temperature and Airflow.

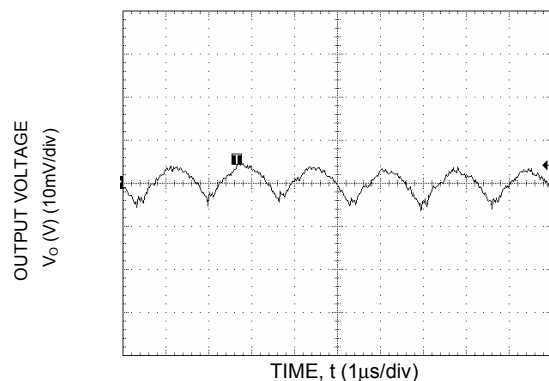


Figure 3. Typical output ripple and noise ($V_{IN} = 12V$, $I_o = I_{o,max}$).

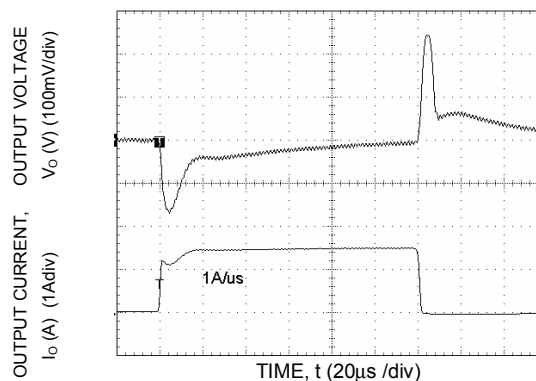


Figure 4. Transient Response to Dynamic Load Change from 0% to 50% to 0% .

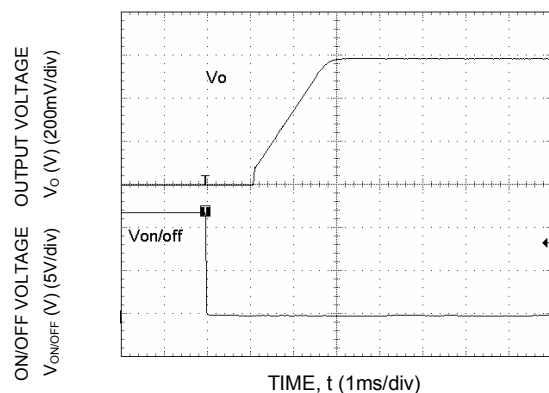


Figure 5. Typical Start-up Using On/Off Voltage ($I_o = I_{o,max}$).

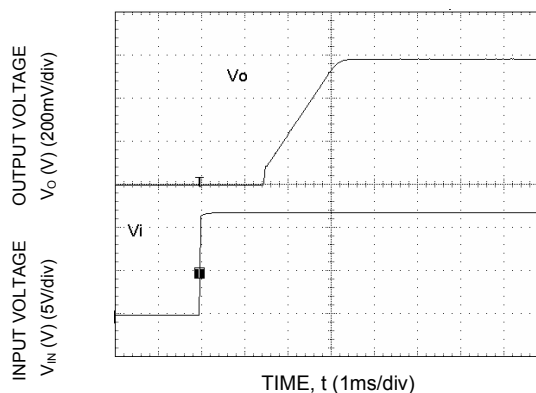


Figure 6. Typical Start-up Using Input Voltage ($V_{IN} = 12V$, $I_o = I_{o,max}$).

Characteristic Curves

The following figures provide typical characteristics for the APTS/APXS003A0X-SRZ (1.2V, 3A) at 25°C.

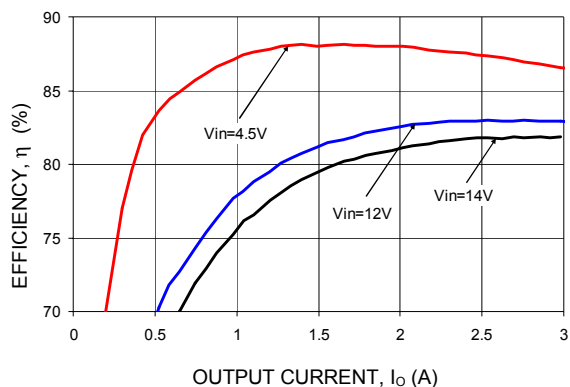


Figure 7. Converter Efficiency versus Output Current.

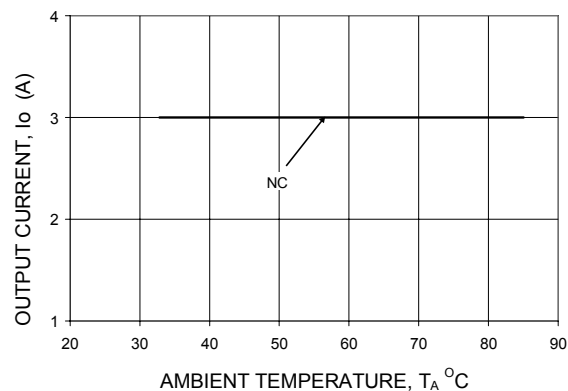


Figure 8. Derating Output Current versus Ambient Temperature and Airflow.

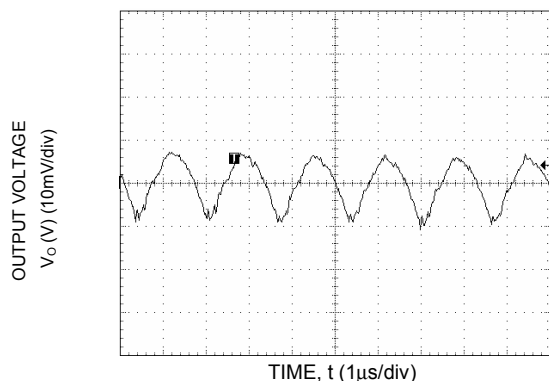


Figure 9. Typical output ripple and noise ($V_{IN} = 12V$, $I_o = I_{o,max}$).

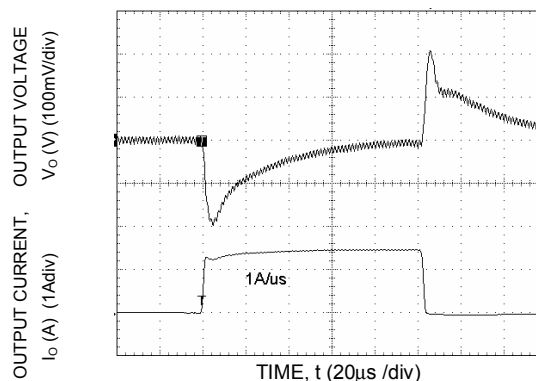


Figure 10. Transient Response to Dynamic Load Change from 0% to 50% to 0%.

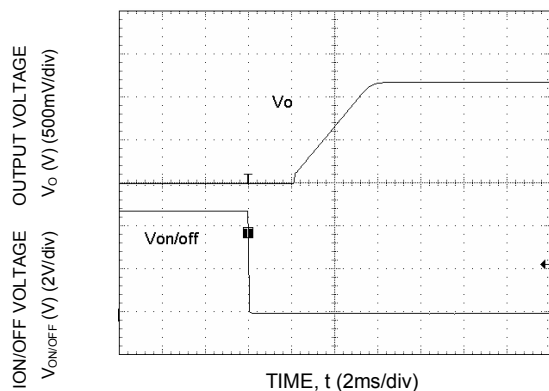


Figure 11. Typical Start-up Using On/Off Voltage ($I_o = I_{o,max}$).

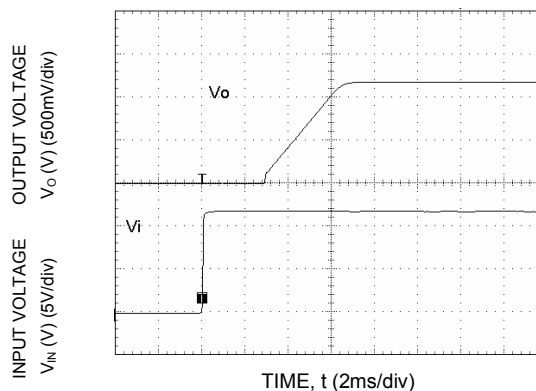


Figure 12. Typical Start-up Using Input Voltage ($V_{IN} = 12V$, $I_o = I_{o,max}$).

Characteristic Curves

The following figures provide typical characteristics for the APTS/APXS003A0X-SRZ (1.8V, 3A) at 25°C.

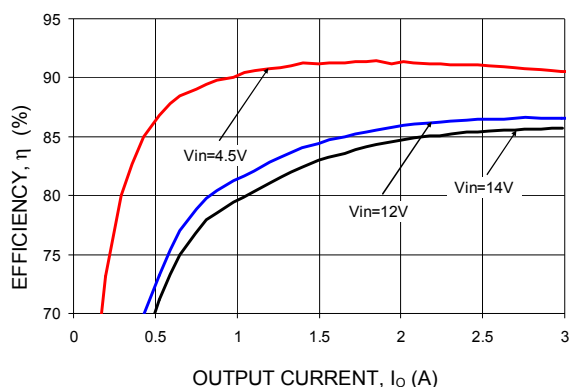


Figure 13. Converter Efficiency versus Output Current.

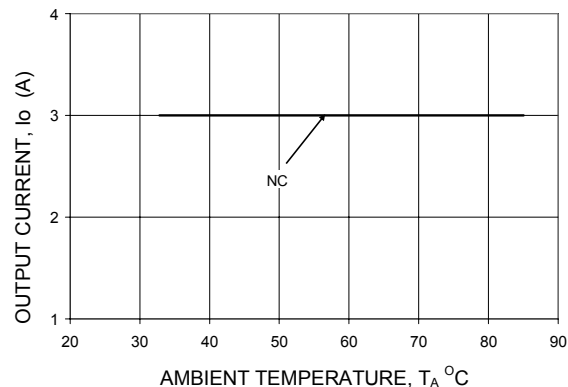


Figure 14. Derating Output Current versus Ambient Temperature and Airflow.

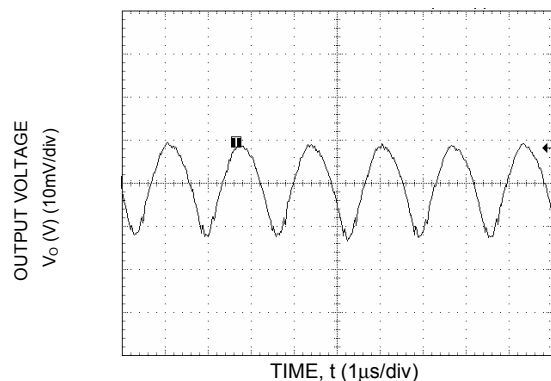


Figure 15. Typical output ripple and noise ($V_{IN} = 12V$, $I_o = I_{o,max}$).

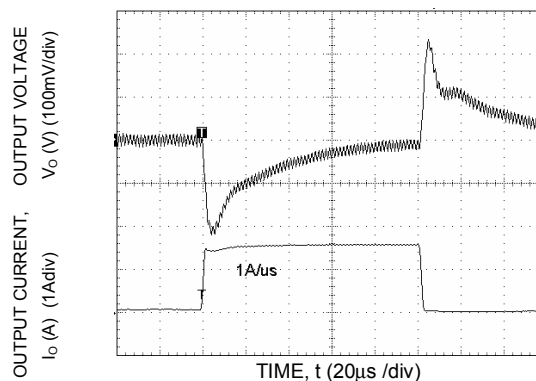


Figure 16. Transient Response to Dynamic Load Change from 0% to 50% to 0%.

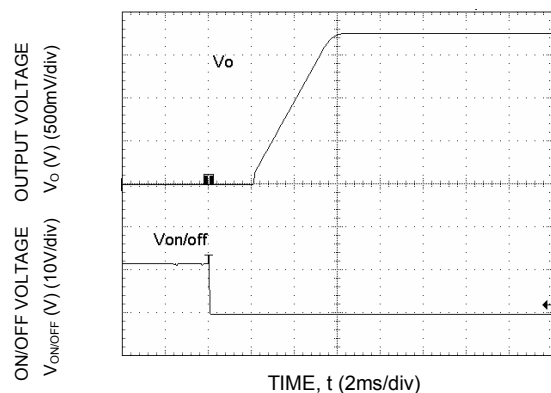


Figure 17. Typical Start-up Using On/Off Voltage ($I_o = I_{o,max}$).

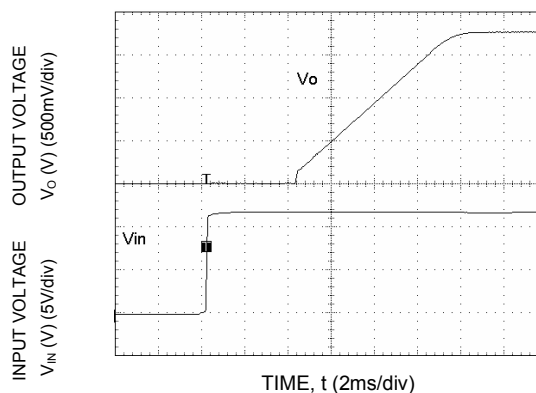


Figure 18. Typical Start-up Using Input Voltage ($V_{IN} = 12V$, $I_o = I_{o,max}$).

Characteristic Curves

The following figures provide typical characteristics for the APTS/APXS003A0X-SRZ (2.5V, 3A) at 25°C.

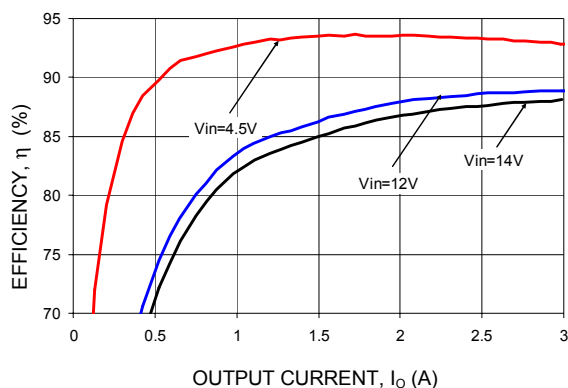


Figure 19. Converter Efficiency versus Output Current.

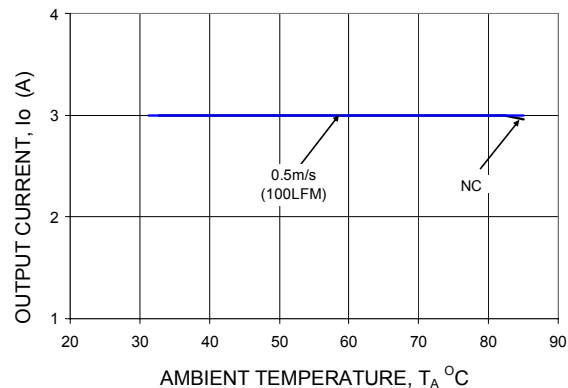


Figure 20. Derating Output Current versus Ambient Temperature and Airflow.

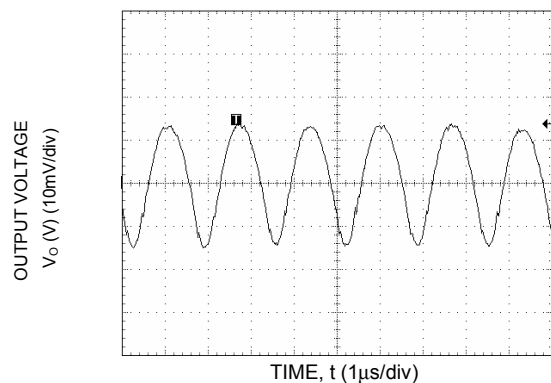


Figure 21. Typical output ripple and noise ($V_{IN} = 12V$, $I_o = I_{o,max}$).

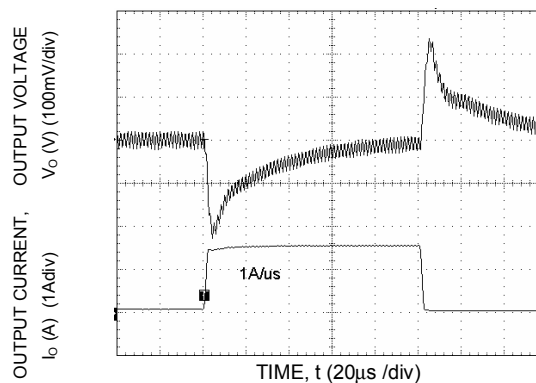


Figure 22. Transient Response to Dynamic Load Change from 0% to 50% to 0%.

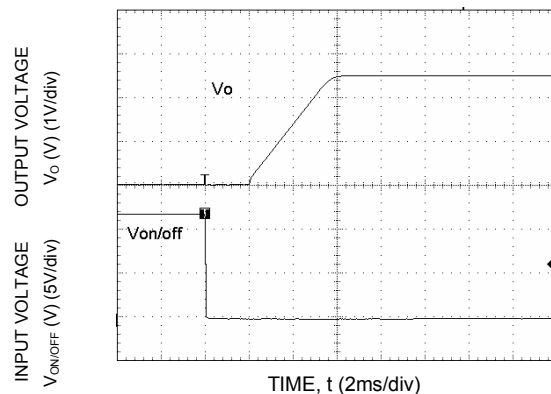


Figure 23. Typical Start-up Using On/Off Voltage ($I_o = I_{o,max}$).

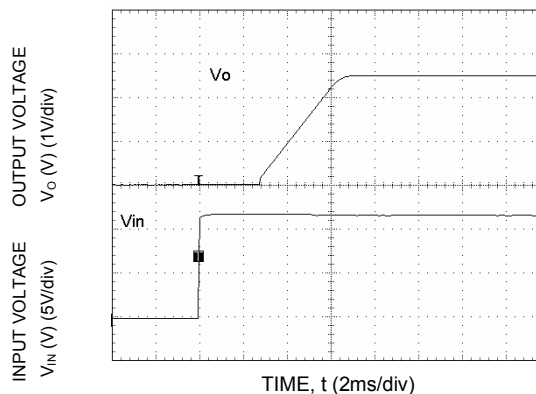


Figure 24. Typical Start-up Using Input Voltage ($V_{IN} = 12V$, $I_o = I_{o,max}$).

Characteristic Curves

The following figures provide typical characteristics for the APTS/APXS003A0X-SRZ (3.3V, 3A) at 25°C.

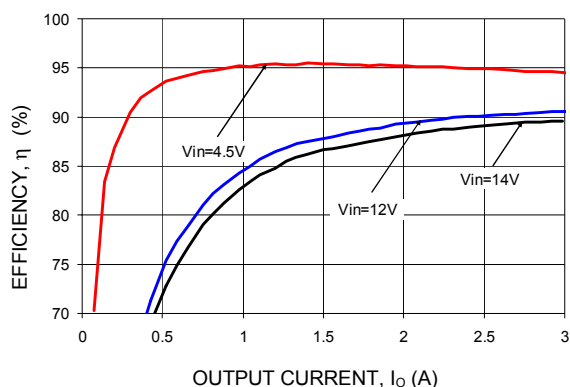


Figure 25. Converter Efficiency versus Output Current.

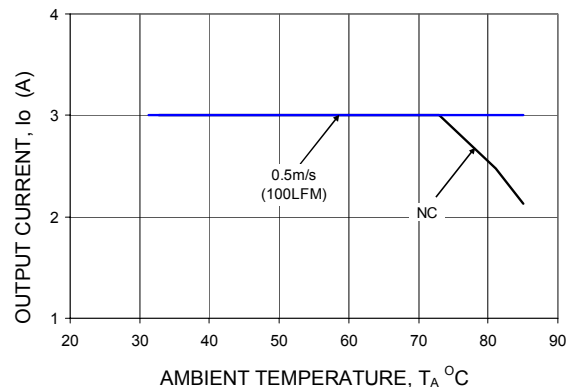


Figure 26. Derating Output Current versus Ambient Temperature and Airflow.

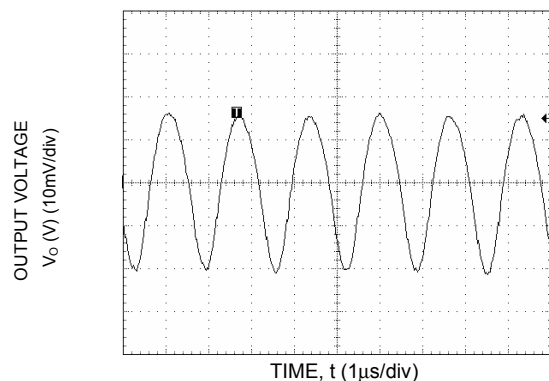


Figure 27. Typical output ripple and noise ($V_{IN} = 12V$, $I_o = I_{o,max}$).

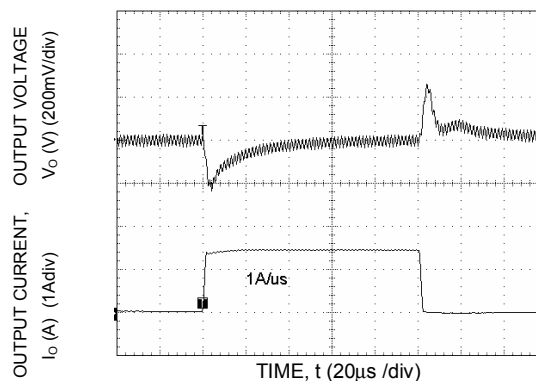


Figure 28. Transient Response to Dynamic Load Change from 0% 50% to 0%.

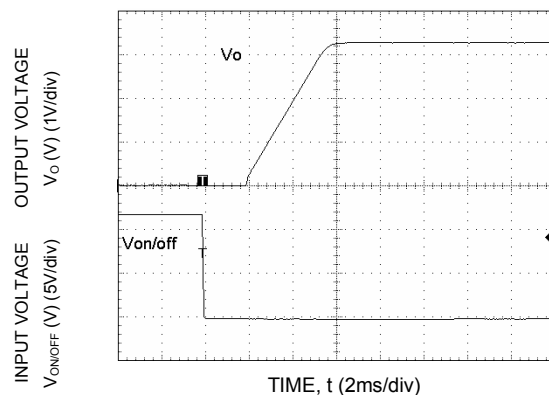


Figure 29. Typical Start-up Using On/Off Voltage ($I_o = I_{o,max}$).

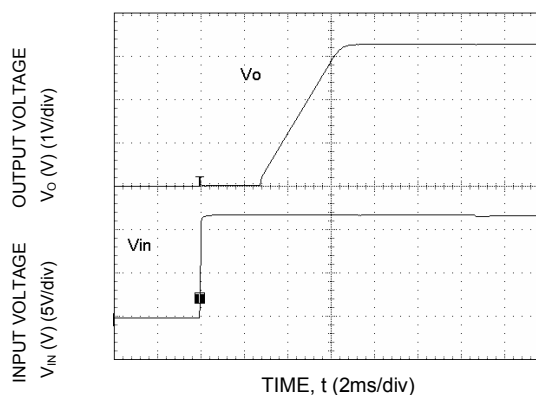


Figure 30. Typical Start-up Using Input Voltage ($V_{IN} = 12V$, $I_o = I_{o,max}$).

Characteristic Curves

The following figures provide typical characteristics for the APTS/APXS003A0X-SRZ (5V, 3A) at 25°C.

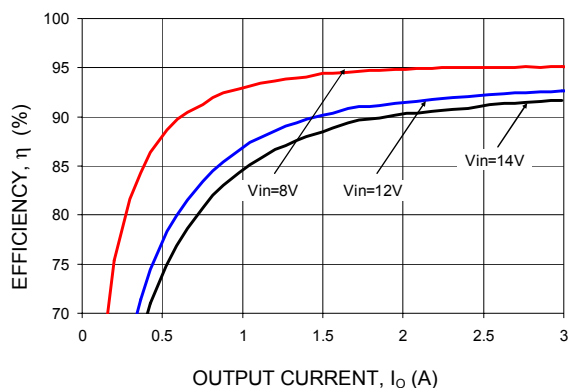


Figure 31. Converter Efficiency versus Output Current.

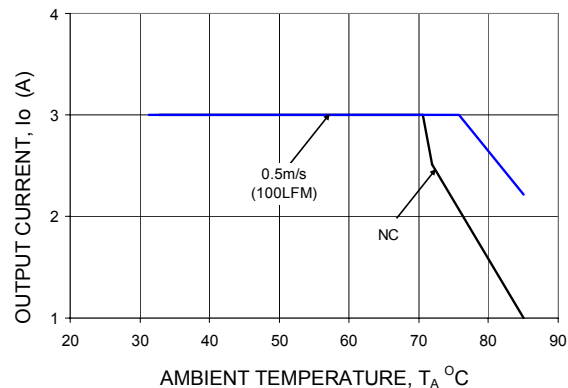


Figure 34. Derating Output Current versus Ambient Temperature and Airflow.

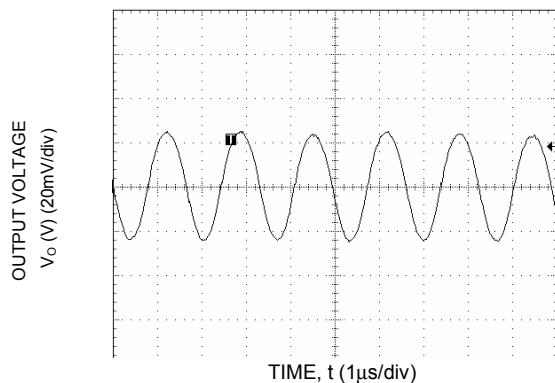


Figure 32. Typical output ripple and noise ($V_{IN} = 12V$, $I_o = I_{o,max}$).

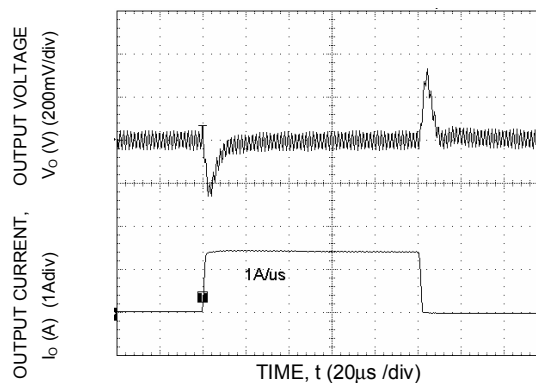


Figure 35. Transient Response to Dynamic Load Change from 0% 50% to 0%.

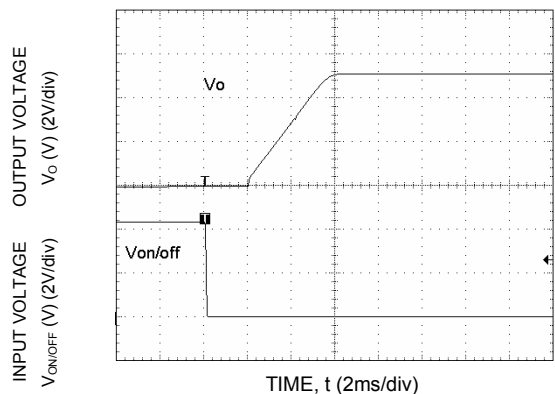


Figure 33. Typical Start-up Using On/Off Voltage ($I_o = I_{o,max}$).

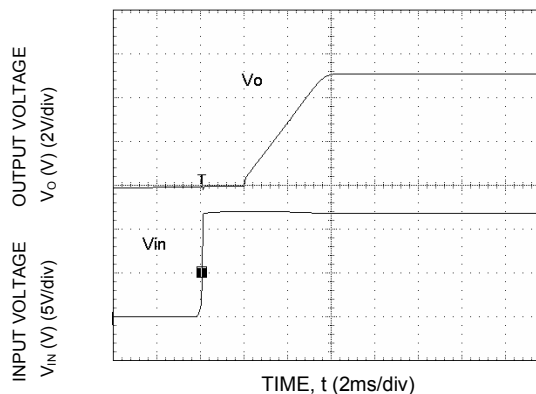
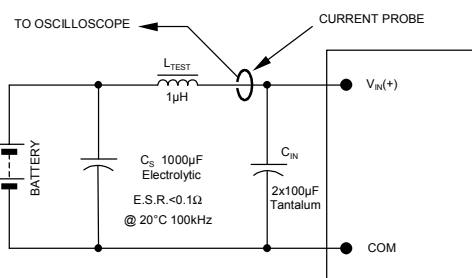


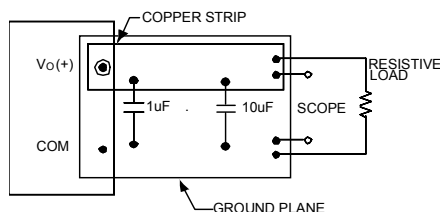
Figure 36. Typical Start-up Using Input Voltage ($V_{IN} = 12V$, $I_o = I_{o,max}$).

Test Configurations



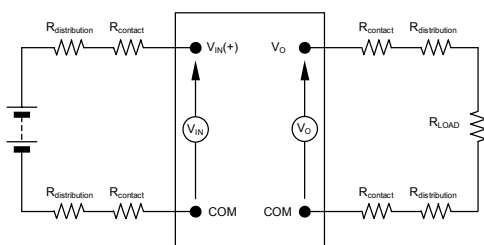
NOTE: Measure input reflected ripple current with a simulated source inductance (L_{TEST}) of 1µH. Capacitor C_S offsets possible battery impedance. Measure current as shown above.

Figure 37. Input Reflected Ripple Current Test Setup.



NOTE: All voltage measurements to be taken at the module terminals, as shown above. If sockets are used then Kelvin connections are required at the module terminals to avoid measurement errors due to socket contact resistance.

Figure 38. Output Ripple and Noise Test Setup.



NOTE: All voltage measurements to be taken at the module terminals, as shown above. If sockets are used then Kelvin connections are required at the module terminals to avoid measurement errors due to socket contact resistance.

Figure 39. Output Voltage and Efficiency Test Setup.

$$\text{Efficiency } \eta = \frac{V_O \cdot I_O}{V_{IN} \cdot I_{IN}} \times 100 \%$$

Design Considerations

Input Filtering

The APTS/APXS003A0X module should be connected to a low ac-impedance source. A highly inductive source can affect the stability of the module. An input capacitance must be placed directly adjacent to the input pin of the module, to minimize input ripple voltage and ensure module stability.

To minimize input voltage ripple, ceramic capacitors are recommended at the input of the module. Figure 40 shows the input ripple voltage for various output voltages at 3A of load current with 1x10 µF or 1x22 µF ceramic capacitors and an input of 12V.

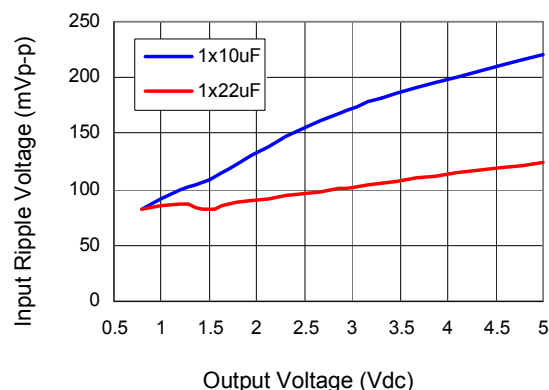


Figure 40. Input ripple voltage for various output voltages with 1x10 µF or 1x22 µF ceramic capacitors at the input (3A load). Input voltage is 12V.

Output Filtering

The APTS/APXS003A0X modules are designed for low output ripple voltage and will meet the maximum output ripple specification with 0.1 µF ceramic and 10 µF ceramic capacitors at the output of the module. However, additional output filtering may be required by the system designer for a number of reasons. First, there may be a need to further reduce the output ripple and noise of the module. Second, the dynamic response characteristics may need to be customized to a particular load step change.

To reduce the output ripple and improve the dynamic response to a step load change, additional capacitance at the output can be used. Low ESR polymer and ceramic capacitors are recommended to improve the dynamic response of the module. For stable operation of the module, limit the capacitance to less than the maximum output capacitance as specified in the electrical specification table. Optimal performance of the module can be achieved by using the Tunable Loop feature described later in this data sheet.

Safety Considerations

For safety agency approval the power module must be installed in compliance with the spacing and separation requirements of the end-use safety agency standards, i.e., UL 60950-1, CSA C22.2 No. 60950-1-03, and VDE 0850:2001-12 (EN60950-1) Licensed.

For the converter output to be considered meeting the requirements of safety extra-low voltage (SELV), the input must meet SELV requirements. The power module has extra-low voltage (ELV) outputs when all inputs are ELV.

The input to these units is to be provided with a fast-acting fuse with a maximum rating of 5A in the positive input lead.

Feature Descriptions

Remote On/Off

The APTS/APXS003A0X power modules feature an On/Off pin for remote On/Off operation. Two On/Off logic options are available. In the Positive Logic On/Off option, device code suffix "4", the module turns ON during a logic High on the On/Off pin and turns OFF during a logic Low. With the Negative Logic On/Off option, no device code suffix, the module turns OFF during logic High and ON during logic Low. The On/Off signal is always referenced to ground. For either On/Off logic option, leaving the On/Off pin disconnected will turn the module ON when input voltage is present.

For positive logic modules, the circuit configuration for using the On/Off pin is shown in Figure 41. When the external transistor Q1 is in the OFF state, the internal transistor On/Off pin is pulled high internally and through the external pullup resistor and the module is ON. When transistor Q1 is turned ON, the On/Off pin is pulled low and the module is OFF.

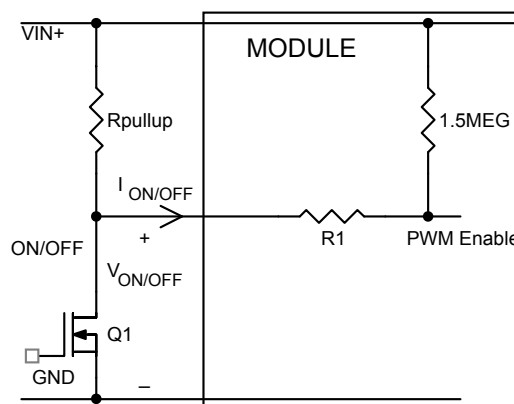


Figure 41. Circuit configuration for using positive On/Off logic.

For negative logic On/Off modules, the circuit configuration is shown in Fig. 42. The On/Off pin should be pulled high with an external pull-up resistor (suggested value for the 4.5V to 14V input range is 20Kohms). When transistor Q2 is in the OFF state, the On/Off pin is pulled high, transistor Q1 is turned ON and the module is OFF. To turn the module ON, Q2 is turned ON pulling the On/Off pin low, turning transistor Q1 OFF resulting in the PWM Enable pin going high.

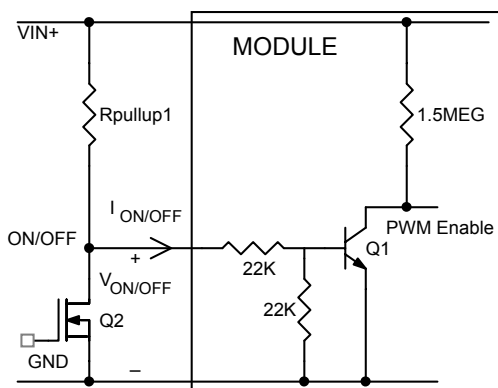


Figure 42. Circuit configuration for using negative On/Off logic.

Overcurrent Protection

To provide protection in a fault (output overload) condition, the unit is equipped with internal current-limiting circuitry and can endure current limiting continuously. At the point of current-limit inception, the unit enters hiccup mode. The unit operates normally once the output current is brought back into its specified range.

Over Temperature Protection

To provide protection in a fault condition, the unit is equipped with a thermal shutdown circuit. The unit will shutdown if the overtemperature threshold of TBD°C is exceeded at the thermal reference point T_{ref} . The thermal shutdown is not intended as a guarantee that the unit will survive temperatures beyond its rating. Once the unit goes into thermal shutdown it will then wait to cool before attempting to restart.

Input Undervoltage Lockout

At input voltages below the input undervoltage lockout limit, the module operation is disabled. The module will begin to operate at an input voltage above the undervoltage lockout turn-on threshold.

Output Voltage Programming

The output voltage of the APTS/APXS003A0X module can be programmed to any voltage from 0.59Vdc to 5.5Vdc by connecting a resistor between the Trim and GND pins of the module. Certain restrictions apply on the output voltage set point depending on the input voltage. These are shown in the Output Voltage vs. Input Voltage Set Point Area plot in Fig. 43. The Upper Limit curve shows that for output voltages of 0.9V and lower, the input voltage must be lower than the maximum of 14V. The Lower Limit curve shows that for output voltages of 3.8V and higher, the input voltage needs to be larger than the minimum of 4.5V.

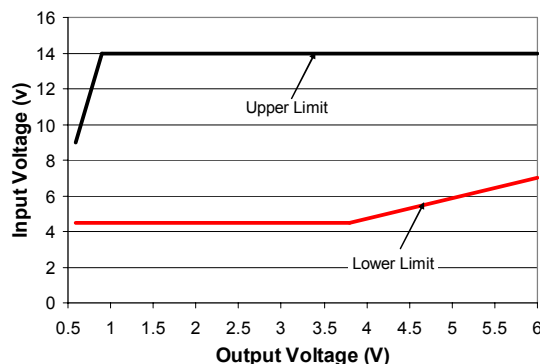


Figure 43. Output Voltage vs. Input Voltage Set Point Area plot showing limits where the output voltage can be set for different input voltages.

Without an external resistor between Trim and GND pins, the output of the module will be 0.59Vdc. To calculate the value of the trim resistor, R_{trim} for a desired output voltage, use the following equation:

$$R_{trim} = \left[\frac{5.91}{(V_o - 0.59)} \right] k\Omega$$

R_{trim} is the external resistor in $k\Omega$

V_o is the desired output voltage.

Table 1 provides R_{trim} values required for some common output voltages.

Table 1

$V_{o, set}$ (V)	R_{trim} (K Ω)
0.6	656.7
1.0	14.45
1.2	9.704
1.5	6.502
1.8	4.888
2.5	3.096
3.3	2.182
5.0	1.340

By using a $\pm 0.5\%$ tolerance trim resistor with a TC of ± 100 ppm, a set point tolerance of $\pm 1.5\%$ can be achieved as specified in the electrical specification.

Remote Sense

The APTS/APXS003A0X power modules have a Remote Sense feature to minimize the effects of distribution losses by regulating the voltage at the SENSE pin. The voltage between the SENSE pin and VOUT pin must not exceed 0.5V. Note that the output voltage of the module cannot exceed the specified maximum value. This includes the voltage drop between the SENSE and Vout pins. When the Remote Sense feature is not being used, connect the SENSE pin to the VOUT pin.

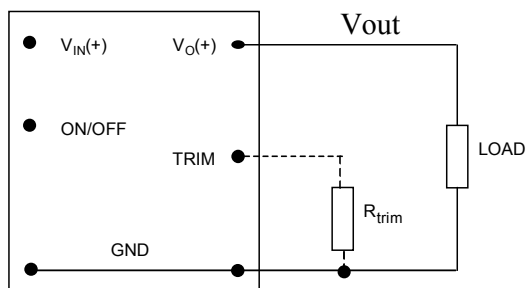


Figure 44. Circuit configuration for programming output voltage using an external resistor.

Remote Sense

The APTS/APXS003A0X power modules have a Remote Sense feature to minimize the effects of distribution losses by regulating the voltage at the SENSE pin. The voltage between the SENSE pin and VOUT pin must not exceed 0.5V. Note that the output voltage of the module cannot exceed the specified maximum value. This includes the voltage drop between the SENSE and Vout pins. When the Remote Sense feature is not being used, connect the SENSE pin to the VOUT pin.

Voltage Margining

Output voltage margining can be implemented in the APTS/APXS003A0X modules by connecting a resistor, $R_{\text{margin-up}}$, from the Trim pin to the ground pin for margining-up the output voltage and by connecting a resistor, $R_{\text{margin-down}}$, from the Trim pin to output pin for margining-down. Figure 45 shows the circuit configuration for output voltage margining. The POL Programming Tool, available at power.tycoelectronics.com under the Design Tools section, also calculates the values of $R_{\text{margin-up}}$ and $R_{\text{margin-down}}$ for a specific output voltage and % margin. Please consult your local Tyco Field Application Engineer or Account Manager for additional details.

Monotonic Start-up and Shutdown

The APTS/APXS003A0X Series modules have monotonic start-up and shutdown behavior for any combination of rated input voltage, output current and operating temperature range.

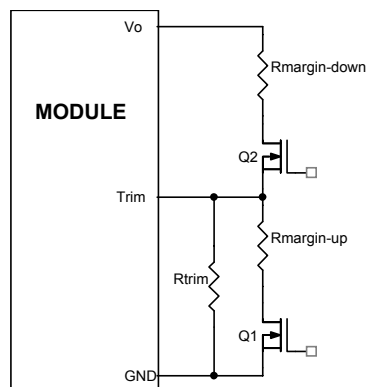


Figure 45. Circuit Configuration for margining Output voltage

Monotonic Start-up and Shutdown

The APTS/APXS003A0X Series modules have monotonic start-up and shutdown behavior for any combination of rated input voltage, output current and operating temperature range.

Output Voltage Sequencing

The APTS003A0X modules include a sequencing feature, EZ-SEQUENCE that enables users to implement various types of output voltage sequencing in their applications. This is accomplished via an additional sequencing pin. When not using the sequencing feature, either tie the SEQ pin to V_{IN} or leave it unconnected.

When an analog voltage is applied to the SEQ pin, the output voltage tracks this voltage until the output reaches the set-point voltage. The final value of the SEQ voltage must be set higher than the set-point voltage of the module. The output voltage follows the voltage on the SEQ pin on a one-to-one volt basis. By connecting multiple modules together, multiple modules can track their output voltages to the voltage applied on the SEQ pin.

For proper voltage sequencing, first, input voltage is applied to the module. The On/Off pin of the module is left unconnected (or tied to GND for negative logic modules or tied to V_{IN} for positive logic modules) so that the module is ON by default. After applying input voltage to the module, a minimum 10msec delay is required before applying voltage on the SEQ pin. During this time, a voltage of 50mV (± 20 mV) is maintained on the SEQ pin.

This can be done by applying the sequencing voltage through a resistor $R1$ connected in series with the SEQ pin as shown in Figure 46. By choosing $R1$ according to the following equation

$$R1 = \frac{24950}{V_{\text{IN}} - 0.05} \text{ ohms,}$$

the voltage at the sequencing pin will be 50mV when the sequencing signal is at zero.

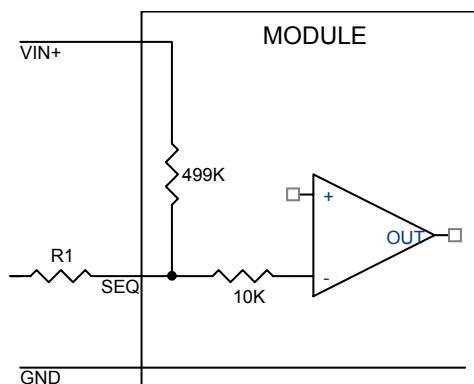


Figure 46. Circuit showing connection of the sequencing signal to the SEQ pin.

After the 10msec delay, an analog voltage is applied to the SEQ pin and the output voltage of the module will track this voltage on a one-to-one volt bases until the output reaches the set-point voltage. To initiate simultaneous shutdown of the modules, the SEQ pin voltage is lowered in a controlled manner. The output voltage of the modules tracks the voltages below their set-point voltages on a one-to-one basis. A valid input voltage must be maintained until the tracking and output voltages reach ground potential.

When using the EZ-SEQUENCE™ feature to control start-up of the module, pre-bias immunity during start-up is disabled. The pre-bias immunity feature of the module relies on the module being in the diode-mode during start-up. When using the EZ-SEQUENCE™ feature, modules goes through an internal set-up time of 10msec, and will be in synchronous rectification mode when the voltage at the SEQ pin is applied. This will result in the module sinking current if a pre-bias voltage is present at the output of the module. When pre-bias immunity during start-up is required, the EZ-SEQUENCE™ feature must be disabled. For additional guidelines on using the EZ-SEQUENCE™ feature please refer to Application Note AN04-008 "Application Guidelines for Non-Isolated Converters: Guidelines for Sequencing of Multiple Modules", or contact the Tyco Power Systems Technical representative for additional information.

Power Good

The APTS/APXS003A0X series of modules provide a Power Good signal that indicates whether or not the power module is functioning properly. PGOOD is a power good signal implemented with an open-drain output to indicate that the output voltage is within the regulation limits of the power module. The PGOOD signal will be de-asserted to a low state if any condition such as overtemperature, overcurrent or loss of regulation occurs that would result in the output voltage going $\pm 10\%$ outside the setpoint value.

The PGOOD terminal should be connected through a pullup resistor to a source of 5VDC or less.

Tunable Loop

The APTS/APXS003A0X series of modules have a new feature that optimizes transient response of the module called Tunable Loop. External capacitors are usually added to improve output voltage transient response due to load current changes. Sensitive loads may also require additional output capacitance to reduce output ripple and noise. Adding external capacitance however affects the voltage control loop of the module, typically causing the loop to slow down with sluggish response. Larger values of external capacitance could also cause the module to become unstable.

To use the additional external capacitors in an optimal manner, the Tunable Loop feature allows the loop to be tuned externally by connecting a series R-C between the SENSE and TRIM pins of the module, as shown in Fig. 47. This R-C allows the user to externally adjust the voltage loop feedback compensation of the module to match the filter network connected to the output of the module.

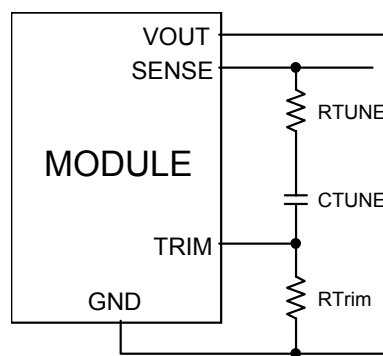


Figure 47. Circuit diagram showing connection of R_{TUNE} and C_{TUNE} to tune the control loop of the module.

Recommended values of R_{TUNE} and C_{TUNE} are given in Tables 2 and 3. Table 2 lists recommended values of R_{TUNE} and C_{TUNE} in order to meet 2% output voltage deviation limits for some common output voltages in the presence of a 1.5A to 3A step change (50% of full load), with an input voltage of 12V. Table 3 shows the recommended values of R_{TUNE} and C_{TUNE} for different values of ceramic output capacitors up to 470uF, again for an input voltage of 5V. Please contact your Tyco Electronics technical representative to obtain more details of this feature as well as for guidelines on how to select the right value of external R-C to tune the module for best transient performance and stable operation for other output capacitance values.

Table 2. Recommended values of R_{TUNE} and C_{TUNE} to obtain transient deviation of 2% of V_{out} for a 1.5A step load with $V_{in}=12V$.

Vout	5V	3.3V	2.5V	1.8V	1.2V	0.6V
Cext	1x22 μ F	1x47 μ F	2x47 μ F	2x47 μ F	3x47 μ F	7x47 μ F
R_{TUNE}	270	270	180	180	120	75
C_{TUNE}	820pF	2200pF	4700pF	4700pF	6800pF	18nF
ΔV	100mV	56mV	33mV	33mV	24mV	11mV

Table 3. General recommended values of R_{TUNE} and C_{TUNE} for $V_{in}=12V$ and various external ceramic capacitor combinations.

Cext	1x47 μ F	2x47 μ F	4x47 μ F	6x47 μ F	10x47 μ F
R_{TUNE}	270	180	100	75	75
C_{TUNE}	2200pF	4700pF	18nF	18nF	22nF

Thermal Considerations

Power modules operate in a variety of thermal environments; however, sufficient cooling should always be provided to help ensure reliable operation.

Considerations include ambient temperature, airflow, module power dissipation, and the need for increased reliability. A reduction in the operating temperature of the module will result in an increase in reliability. The thermal data presented here is based on physical measurements taken in a wind tunnel. The test set-up is shown in Figure 48. The preferred airflow direction for the module is in Figure 48.

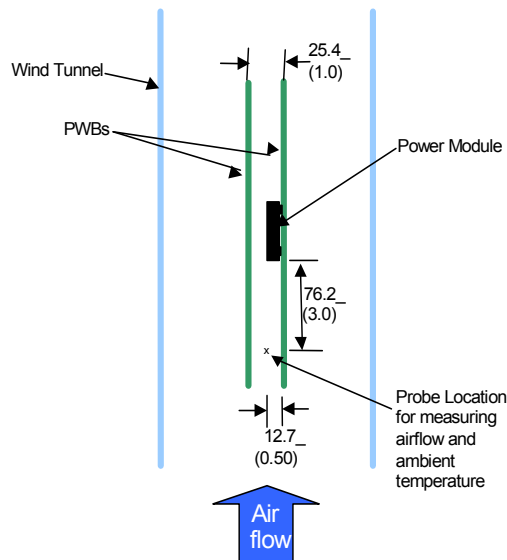


Figure 48. Thermal Test Setup.

The thermal reference points, T_{ref} used in the specifications are also shown in Figure 49. For reliable operation the temperatures at these points should not exceed 125°C. The output power of the module should not exceed the rated power of the module ($V_{o,set} \times I_{o,max}$).

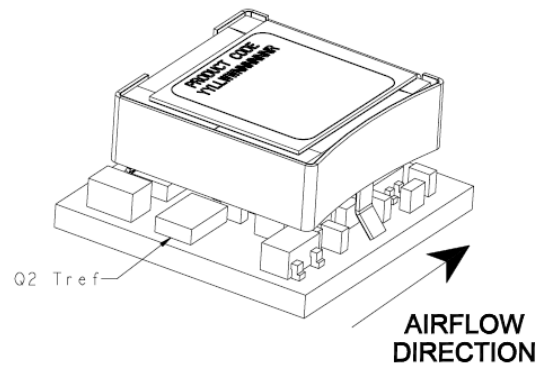


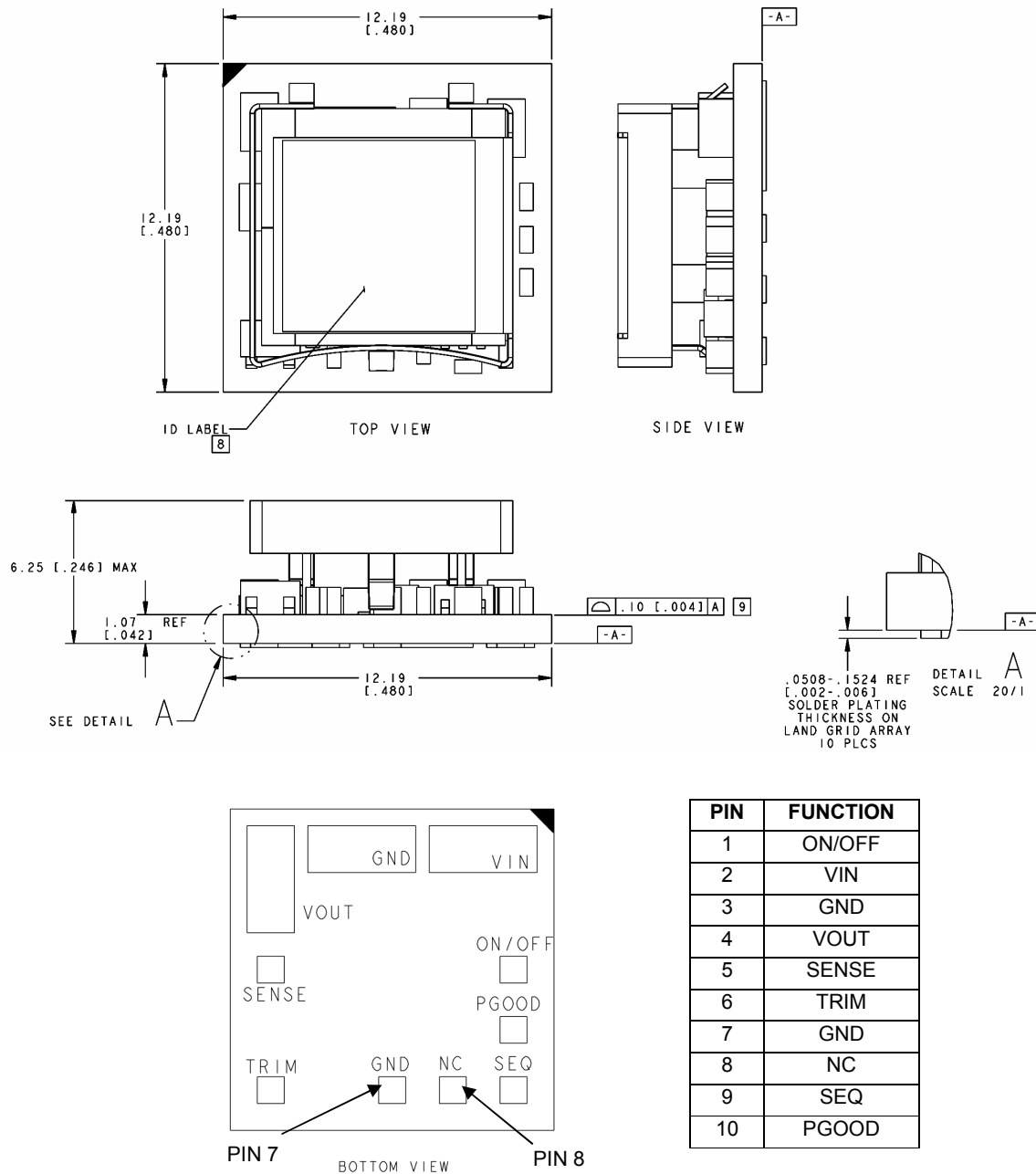
Figure 49. Preferred airflow direction and location of hot-spot of the module (T_{ref}).

Mechanical Outline

Dimensions are in millimeters and (inches).

Tolerances: x.x mm $\pm$ 0.5 mm (x.xx in. $\pm$ 0.02 in.) [unless otherwise indicated]

x.xx mm $\pm$ 0.25 mm (x.xxx in. $\pm$ 0.010 in.)

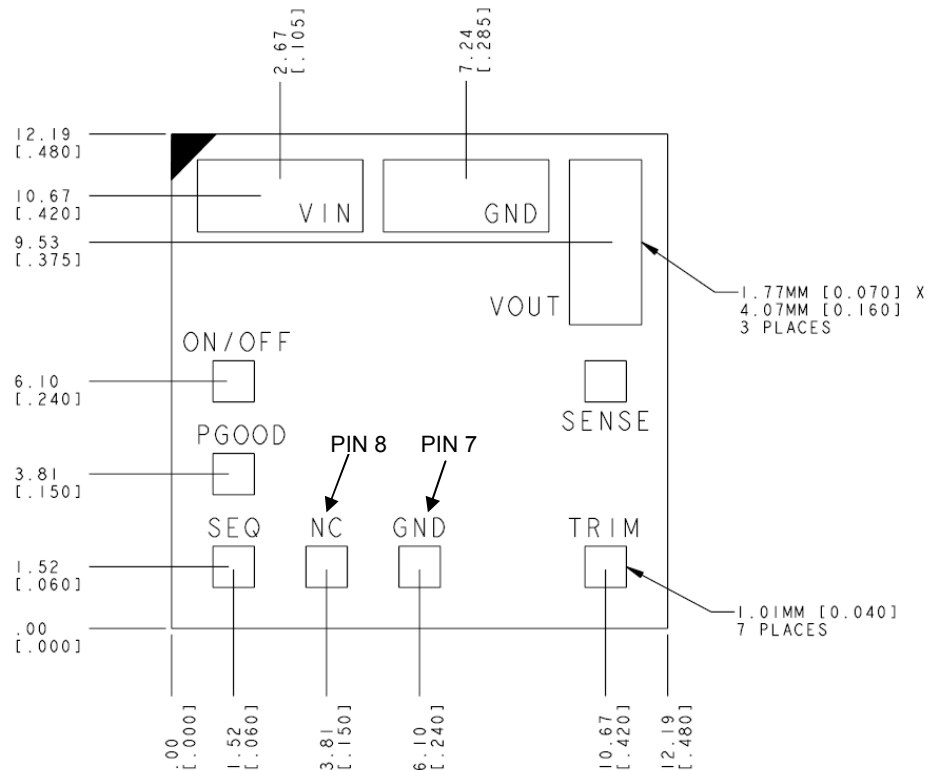


Recommended Pad Layout

Dimensions are in millimeters and (inches).

Tolerances: $x.x \text{ mm} \pm 0.5 \text{ mm}$ ($x.xx \text{ in.} \pm 0.02 \text{ in.}$) [unless otherwise indicated]

$x.xx \text{ mm} \pm 0.25 \text{ mm}$ ($x.xxx \text{ in.} \pm 0.010 \text{ in.}$)



RECOMMENDED FOOTPRINT
- THROUGH THE BOARD -

PIN	FUNCTION
1	ON/OFF
2	VIN
3	GND
4	VOUT
5	SENSE
6	TRIM
7	GND
8	NC
9	SEQ
10	PGOOD

The APTS/APXS003A0X modules are supplied in tape & reel as standard. Modules are shipped in quantities of 400 modules per reel.

[illegible]

Outside Dimensions: 330.2 mm (13.00)
Inside Dimensions: 177.8 mm (7.00")
Tape Width: 24.00 mm (0.945")

Surface Mount Information

Pick and Place

The APTS/APXS003A0X modules use an open frame construction and are designed for a fully automated assembly process. The modules are fitted with a label designed to provide a large surface area for pick and place operations. The label meets all the requirements for surface mount processing, as well as safety standards, and is able to withstand reflow temperatures of up to 300°C. The label also carries product information such as product code, serial number and the location of manufacture.

Nozzle Recommendations

The module weight has been kept to a minimum by using open frame construction. Variables such as nozzle size, tip style, vacuum pressure and placement speed should be considered to optimize this process. The minimum recommended inside nozzle diameter for reliable operation is 3mm. The maximum nozzle outer diameter, which will safely fit within the allowable component spacing, is 7 mm.

Lead Free Soldering

The APTS/APXS003A0X SMT modules are lead-free (Pb-free) and RoHS compliant and fully compatible in a Pb-free soldering process. Failure to observe the instructions below may result in the failure of or cause damage to the modules and can adversely affect long-term reliability.

Pb-free Reflow Profile

Power Systems will comply with J-STD-020 Rev. C (Moisture/Reflow Sensitivity Classification for Nonhermetic Solid State Surface Mount Devices) for both Pb-free solder profiles and MSL classification procedures. This standard provides a recommended forced-air-convection reflow profile based on the volume and thickness of the package (table 4-2). The suggested Pb-free solder paste is Sn/Ag/Cu (SAC). The recommended linear reflow profile using Sn/Ag/Cu solder is shown in Fig. 50. Soldering outside of the recommended profile requires testing to verify results and performance.

MSL Rating

The APTS/APXS003A0X modules have a MSL rating of 2.

Storage and Handling

The recommended storage environment and handling procedures for moisture-sensitive surface mount packages is detailed in J-STD-033 Rev. A (Handling, Packing, Shipping and Use of Moisture/Reflow Sensitive Surface Mount Devices). Moisture barrier

bags (MBB) with desiccant are required for MSL ratings of 2 or greater. These sealed packages should not be broken until time of use. Once the original package is broken, the floor life of the product at conditions of $\leq 30^{\circ}\text{C}$ and 60% relative humidity varies according to the MSL rating (see J-STD-033A). The shelf life for dry packed SMT packages will be a minimum of 12 months from the bag seal date, when stored at the following conditions: $< 40^{\circ}\text{C}$, $< 90\%$ relative humidity.

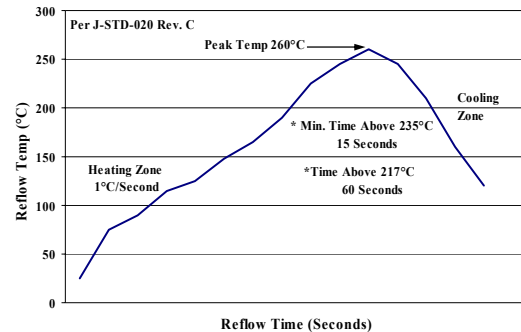


Figure 50. Recommended linear reflow profile using Sn/Ag/Cu solder.

Post Solder Cleaning and Drying Considerations

Post solder cleaning is usually the final circuit-board assembly process prior to electrical board testing. The result of inadequate cleaning and drying can affect both the reliability of a power module and the testability of the finished circuit-board assembly. For guidance on appropriate soldering, cleaning and drying procedures, refer to Tyco Electronics *Board Mounted Power Modules: Soldering and Cleaning* Application Note (AN04-001).

Ordering Information

Please contact your Tyco Electronics' Sales Representative for pricing, availability and optional features.

Table 1. Device Codes

Device Code	Input Voltage Range	Output Voltage	Output Current	On/Off Logic	Sequencing	Comcodes
APTS003A0X-SRZ	4.5 – 14Vdc	0.59 – 5.5Vdc	3A	Negative	Yes	CC109125985
APTS003A0X4-SRZ	4.5 – 14Vdc	0.59 – 5.5Vdc	3A	Positive	Yes	CC109125993
APXS003A0X-SRZ	4.5 – 14Vdc	0.59 – 5.5Vdc	3A	Negative	No	CC109125952
APXS003A0X4-SRZ	4.5 – 14Vdc	0.59 – 5.5Vdc	3A	Positive	No	CC109125977



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